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Part Number: [0432028918](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Shielded, Offset Panel Grounding Tabs, with Bottom Grounding Tab, Front Position PCB Ground Tab, 8/8

Documents:
[3D Model](#) [Product Specification PS-43202-001 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
UL E107635

General

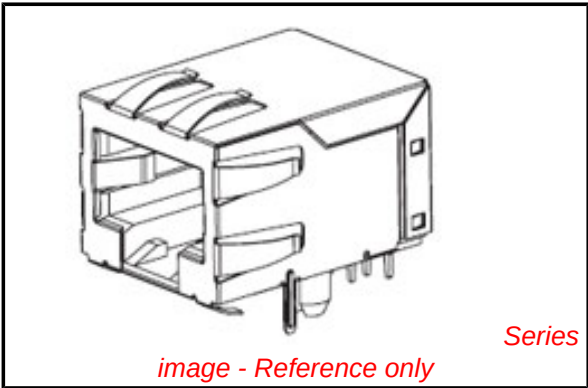
Product Family Modular Jacks/Plugs
Series [43202](#)
Comments Enhanced panel grounding tabs
Component Type PCB Jack
Magnetic No
Overview [modular_plugs_jacks](#)
Performance Category 3
Power over Ethernet (PoE) N/A
Product Name RJ45

Physical

Color - Resin Black
Durability (mating cycles max) 500
Flammability 94V-0
Inverted / Top Latch No
Lightpipes/LEDs None
Material - Metal Brass, Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic
Orientation Right Angle (Side Entry)
PCB Retention Yes
PCB Thickness Recommended (in) 0.062 In
PCB Thickness Recommended (mm) 1.60 mm
Packaging Type Tray
Panel Mount With Flange
Pitch - Mating Interface (in) 0.050 In
Pitch - Mating Interface (mm) 1.27 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25
Plating min: Termination (µin) 100
Plating min: Termination (µm) 2.5
Ports 1
Positions / Loaded Contacts 8/8
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -40°C to +85°C
Termination Interface: Style Through Hole
Wire/Cable Type N/A

Electrical

Current - Maximum per Contact 1.5A



EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Not Reviewed
**Halogen-Free
Status**
Not Reviewed

China RoHS



**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
[43202Series](#)

Mates With
FCC 68 Plugs

Grounding to PCB	Yes
Grounding to Panel	Offset Panel Ground Tabs
Shielded	Yes
Voltage - Maximum	125V
Solder Process Data	
Lead-free Process Capability	Wave Capable (TH only)
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-43202-004
Product Specification	PS-43202-001, RPS-43202-002
Sales Drawing	SDA-43202

This document was generated on 06/07/2010

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NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
TERMINALS: PHOSPHOR BRONZE, .012/ 0.30 THICK
SHIELD: BRASS, .007/ 0.18 THICK

2) FINISH:

TERMINALS:

A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AND/OR SHIELD.

SHIELD:

100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27
MICROMETERS COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43202.

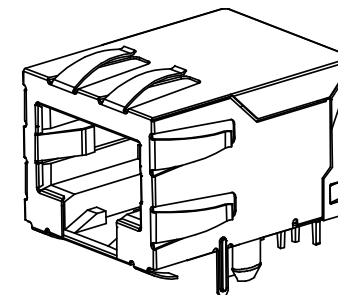
4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-003.
UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
PER MOLEX PACKAGING SPECIFICATION PK-43202-005.
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-004.

5) SEE SHEETS 7 - 9 FOR P.C. BOARD LAYOUTS.

6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



SHIELDED MODULAR JACK
SHOWN WITH PANEL GROUND
OPTION 'D' AND FRONT
PCB GROUND TABS.

DRAWING LEGEND

SHEET 1- NOTES, DRAWING LEGEND
SHEET 2- SHIELDED MODULAR JACK W/ BOTTOM GROUND TABS
SHEET 3- SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS
SHEET 4- UNSHIELDED MODULAR JACK
SHEET 5- PART NUMBER CHARTS
SHEET 6- PART NUMBER CHARTS
SHEET 7- FOOTPRINT LAYOUT FOR 4 POSITION HOUSING
SHEET 8- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING
SHEET 9- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING

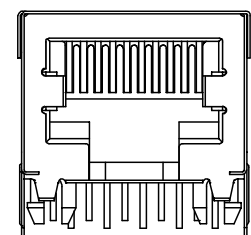
OBS COLORED JACKS EC NO: UCP2008-1189 DRAWN:JBELL 2007/11/30 CHKD:LSCHMIDT 2008/02/20 APPR:FSM/TH 2008/03/04	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION				
		mm INCH		DRAWN BY JTR	DATE 1993/03/31	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX MOLEX INCORPORATED						
		4 PLACES ± --- ± ---		CHECKED BY JTR	DATE 1993/03/31							
		3 PLACES ± --- ± .010		APPROVED BY RAS							DATE 1993/03/31	
		2 PLACES ± 0.25 ± .014		MATERIAL NO.							DOCUMENT NO.	SHEET NO.
		1 PLACE ± 0.36 ± ---		SEE SHTS 5&6							SDA-43202	
		ANGULAR ± 1/2°		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

9	L2
8	L2
7	L2
6	L4
5	L
4	K2
3	L1
2	L1
1	L4
SH	REV

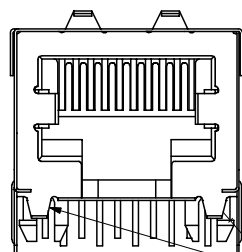
SHIELDED MODULAR JACK W/BOTTOM GROUND TABS

SIZE 8 LOADED 10 VERSION SHOWN

SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



OPTION "A"
NO TOP OR SIDE TABS

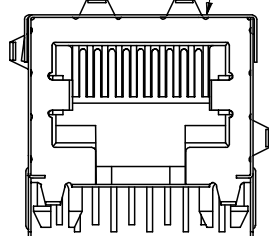


OPTION "B"
TOP TABS

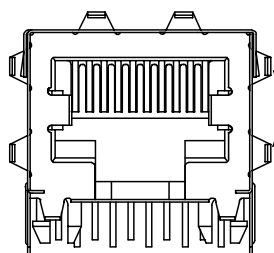
BOTTOM
GROUND TABS

OPTIONAL TOP GROUND TABS

SHIELDED MODULAR JACK ASSEMBLY
SEE SHEET 5 FOR MATERIAL NO.

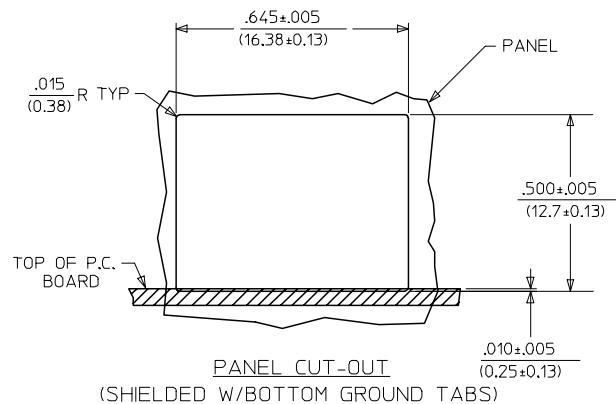
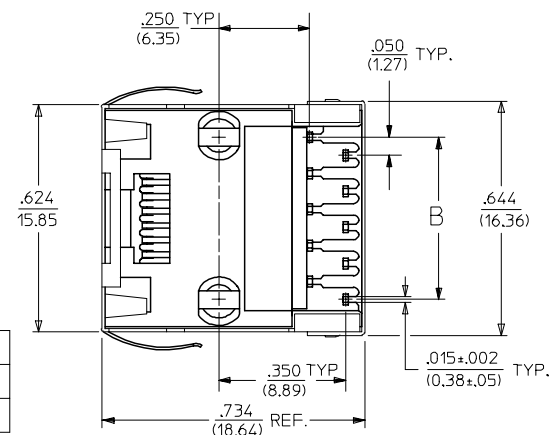
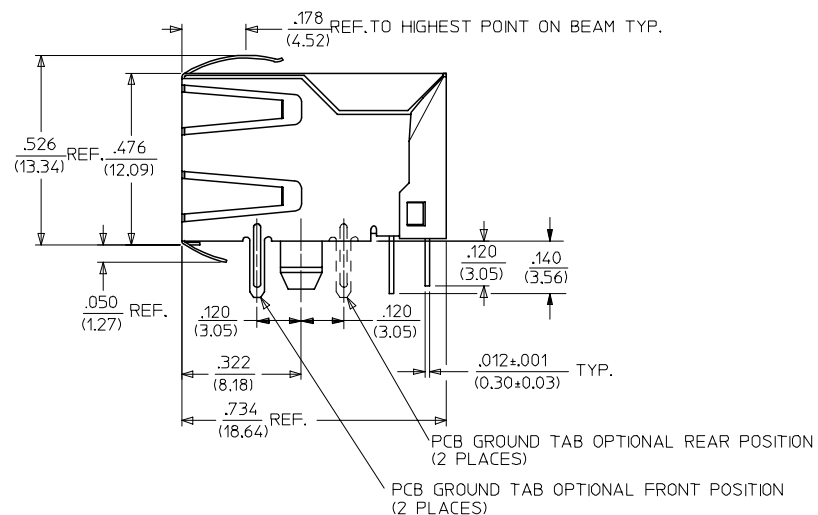


OPTION "C"
TOP AND STAGGERED SIDE TABS



OPTION "D"
TOP AND SIDE TABS

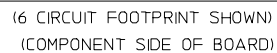
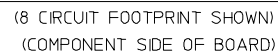
OPTIONAL SIDE
GROUND TABS
(2 PLACES)



HOUSING SIZE	CIRCUIT SIZE	B
8	10	.450±.005 11.43±.13
8	8	.350±.005 8.89±.13

SEE SHEET ONE FC NO: UCP2004-1888 DRAWN: SCHMIDT 2004/03/31 CHKD: SCHMIDT 2004/03/31 APPR: FSMITH 2004/03/31 REV L1	QUALITY SYMBOLS -0 -0	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± .010 2 PLACES ± 0.25 ± .014 1 PLACE ± 0.36 ± --- ANGULAR ±1/2° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SCALE 4:1 DESIGN UNITS INCH DIMENSION STYLE IN/MM DRAWN BY JTR DATE 1993/03/31 CHECKED BY JTR DATE 1993/03/31 APPROVED BY RAS DATE 1993/03/31	THIRD ANGLE PROJECTION REVISE ON CAD ONLY TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED MATERIAL NO. SEE SHT 5 DOCUMENT NO. SDA-43202 SHEET NO. 2 OF 9

	13	12	11	10	9	8	7	6	5	4	3	2	43202		
J	SHIELDED MODULAR JACKS W/BOTTOM GROUND TABS (SHEET 2)														J
	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	TERMINAL PLATING OPTION	PACKAGING OPTION	HOUSING COLOR							
I	43202-8900	8	10	A	FRONT POSITION	A	TRAY	BLACK							
	43202-8901	8	10	B	FRONT POSITION	A	TRAY								
	43202-8902	8	10	C	FRONT POSITION	A	TRAY								
	43202-8903	8	10	D	FRONT POSITION	A	TRAY								
	43202-8908	8	10	A	REAR POSITION	A	TRAY								
H	43202-8909	8	10	B	REAR POSITION	A	TRAY								
	43202-8910	8	10	C	REAR POSITION	A	TRAY								
	43202-8911	8	10	D	REAR POSITION	A	TRAY								
	43202-8916	8	8	A	FRONT POSITION	A	TRAY								
	43202-8917	8	8	B	FRONT POSITION	A	TRAY								
G	43202-8918	8	8	C	FRONT POSITION	A	TRAY								
	43202-8919	8	8	D	FRONT POSITION	A	TRAY								
	43202-8924	8	8	A	REAR POSITION	A	TRAY								
	43202-8925	8	8	B	REAR POSITION	A	TRAY								
	43202-8926	8	8	C	REAR POSITION	A	TRAY								
	43202-8927	8	8	D	REAR POSITION	A	TRAY								
F														F	
E														E	
D														D	
C														C	
B														B	
A														A	
SEE SHEET 1 EC NO: UCP2004-1347 DRWN:MKAMARA0004/02/09 CHKD:MKAMARA0004/02/09 APPR:BMWKUS 2004/02/10 QUALITY SYMBOLS ▽ - 0 ▽ - 0 GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± ± ± ± 3 PLACES ± ± ± ± ±.010 2 PLACES ± ± 0.25 ±.014 1 PLACE ± ± 0.36 ± ± ± ANGULAR ±1/2° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS SCALE 4:1 DESIGN UNITS INCH DIMENSION STYLE IN/MM DRAWN BY JTR DATE 1993/03/18 CHECKED BY JTR DATE 1993/03/18 APPROVED BY RAS DATE 1993/03/18 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION THIRD ANGLE PROJECTION TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX MOLEX INCORPORATED MATERIAL NO. SEE CHART DOCUMENT NO. SDA-43202 SHEET NO. 5 OF 9 REVISE ON CAD ONLY															
	12	11	10	9	8	7	6	5	4	3	2	1			



ib_frame_C_P_ME_T
Rev. C 2002/05/05



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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